

MKT Film Capacitor

Material Data Sheet

Product Class MKT F B3252 Date 18/11/2		FILM (Boxed) 529xx					ſ					
		2019					мкт					
IMDS ID NA if available			la (03/2019)					ľ	~-ſ			
Version 5.02.1												
Product Part (IMDS: semi component)		Aterial Class DS: Material) VDA 231		Substance		TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)			
Active Part	Polymer		2A	Po	yethylene terephth	nalate	(PET)	100	25038-59-9	13,5		
	Heavy metal		1C	Sn				97	7440-31-5	15		
	Heavy metal		10	Cu				3	7440-50-8			
	Light Metals		10 1B	Al				100	7429-90-5			
Enconculation	Ŭ						alata) (DDT)			-		
Encapsulation	Polymer		2A	Poly(1,4-butylene terephtha Fiber Glass			aidie) (PBI)	60	26062-94-2	15	+	
		Materials	3A					21,5	65997-17-3	5		
	Functional Material		4B	Oli	rabromobisphenol gomer (TBBPA)		8.75	71342-77-3	4.0			
	Functional Material		4B	Tetrabromobisphenol A Ether			glycidye	8.75	68928-70-1	4,8		
	Inorganic Solid		4A		Diantimony Trioxide			1	1309-64-4			
	Duromer		2C	Bisphenol A Epoxy Re				90	25068-38-6			
	Acid, Salt, Base		6F	oth	ers *)		10	-	29,9			
Termination	Iron & Steel		1A	Fe				100	7439-89-6	8,3		
	Heavy metal		1C	Cu				100	7440-50-8	2,3		
	Heavy metal		1C	Sn				100	7440-31-5	1,2		
									Sum in total:	100		
sizes [ixwxh] 2.5 x 6.5 x 7.3 mm 3.0 x 6.5 x 7.3 mm 3.5 x 8.0 x 7.3 mm 4.5 x 9.5 x 7.3 mm 5.0 x 10.0 x 7.5 mm 6.0 x 10.5 x 7.5 mm 7.8 x 13.0 x 7.8 mm	weight ran 0,20 0,25 0,32 0,46 0,54 0,68 0,90	ge [g]	part numbers B32529*									
Not Part of a P	oduct Cla	ss										
Contact	Perosa E	duardo				Important remarks:						
Division	CAP FILM	/l, (GTIE	iTI EPQM)			1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are						
Address	TDK Electronics do Brasil Ltda,							t parts, substances etc. that are below a percentage of 0.1 % by weight, if not ise regulated aterial Data Sheet contains typical values of the respective products set forth We expressly point out that all values and statements contained herein are				
	Bernardo Joaquim Ferreira, 624 – Gravataí, RS				6, Brazil 2) This Materia							
:	Tel: +55 51 3				k-electronics.tdk.com	-	based on ou	r best presen	t knowledge and canr	not be regarded as binding	g statement	
 **) typical mass 		•	ed substances acc. G. ance	ADSI	-)		ELECTRON REPRESEN STATUTOR HEREIN, IN	ICS AG AND TATION OR Y, WITH REG CLUDING BU	ITS AFFILIATES HEI WARRANTY, WHETE GARD TO THE STATE IT NOT LIMITED TO	<i>i</i> ise explicitly agreed in wr REBY EXPRESSLY DISC ER EXPRESS, IMPLIED C EMENTS AND VALUES C ANY REPRESENTATION TABILITY FOR ANY PUR	LAÎM ANY DR ONTAINED OR	



RoHS - Exemptions for the Product Class / Product according to	Annex III: (🗹 valid 🗆 not valid)
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☑ no exemptions;

Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;

Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;

Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;

Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);

Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Other Exemption than above